

Electronic Patent Application Fee Transmittal

Application Number:	10667694			
Filing Date:	22-Sep-2003			
Title of Invention:	Integrated circuit die/package interconnect			
First Named Inventor/Applicant Name:	Gilroy J. Vandentop			
Filer:	Mark Steinberg/Edith Martin			
Attorney Docket Number:	P16922			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Notice of appeal	1401	1	500	500
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				500